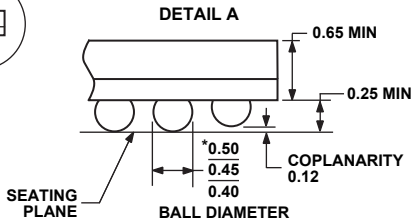
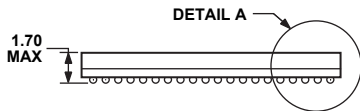
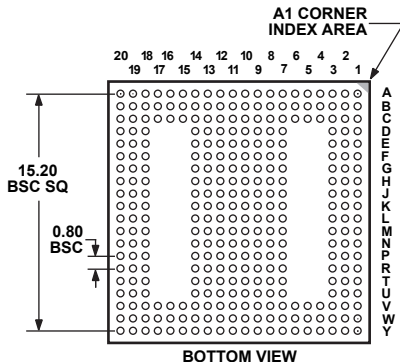
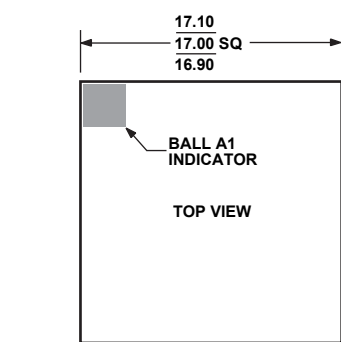


316-Ball Chip Scale Package Ball Grid Array [CSP_BGA] (BC-316)

Dimensions shown in millimeters



***COMPLIANT TO JEDEC STANDARDS MO-205-AM
WITH EXCEPTION TO BALL DIAMETER.**